

QEE122 / QEE123 Plastic Infrared Light Emitting Diode

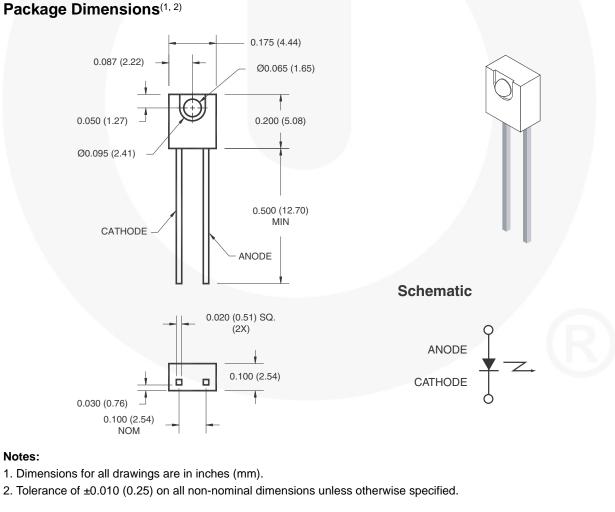
Features

- $\lambda = 880 \text{ nm}$
- Package Type = Sidelooker
- Chip Material = AlGaAs
- Matched Photosensor: QSE113
- Medium Wide Emission Angle, 50°
- Package Material: Clear Epoxy
- High Output Power
- · Orange dot marking on the top side

Package Dimensions^(1, 2)



The QEE12X is a 880 nm AIGaAs LED encapsulated in a medium wide angle, plastic sidelooker package.



May 2015

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit
T _{OPR}	Operating Temperature	-40 to +100	°C
T _{STG}	Storage Temperature	-40 to +100	°C
T _{SOL-I}	Soldering Temperature (Iron) ^(4, 5, 6)	240 for 5 sec	°C
T _{SOL-F}	Soldering Temperature (Flow) ^(4, 5)	260 for 10 sec	°C
١ _F	Continuous Forward Current	100	mA
V _R	Reverse Voltage	5	V
P _D	Power Dissipation ⁽³⁾	100	mW

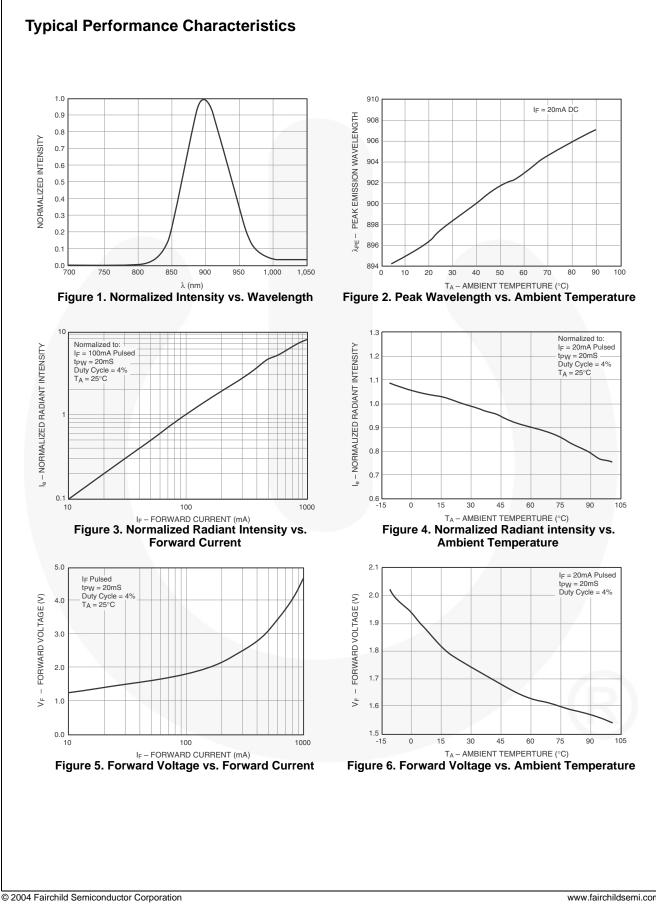
Notes:

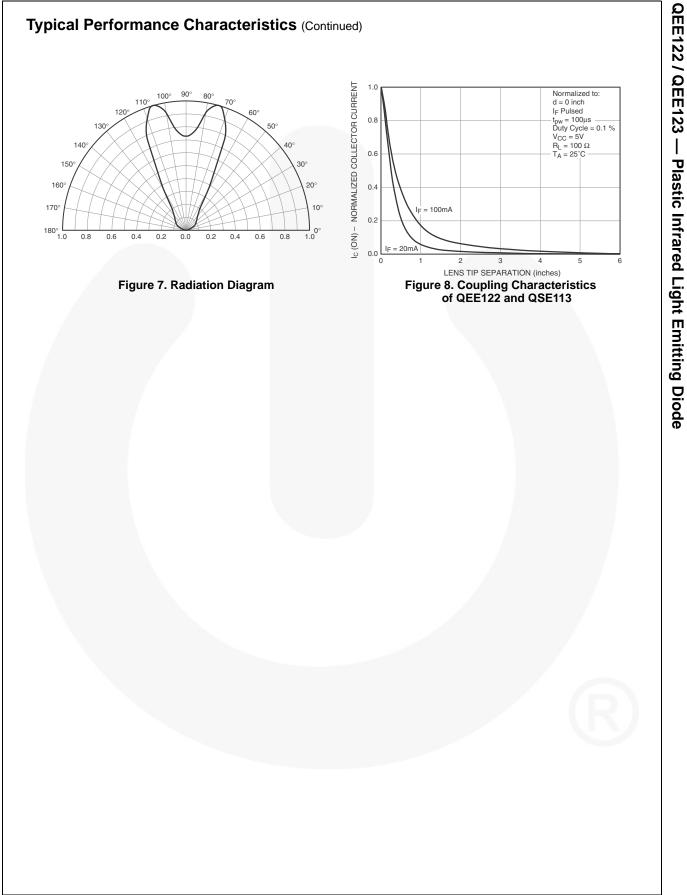
- 3. Derate power dissipation linearly 2.67 mW/°C above 25°C.
- 4. RMA flux is recommended.
- 5. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 6. Soldering iron 1/16" (1.6mm) minimum from housing.

Electrical / Optical Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
λ _{PE}	Peak Emission Wavelength	I _F = 20 mA		890		nm	
TC_{λ}	Temperature Coefficient			0.2		nm/°C	
2Θ ¹ /2	Emission Angle	I _F = 100 mA		50		0	
V _F	Forward Voltage	I _F = 100 mA, tp = 20 ms			1.7	V	
TC _{VF}	Temperature Coefficient			-6		mV/°C	
I _R	Reverse Current	V _R = 5 V			10	μA	
1-	Radiant Intensity QEE122	I _F = 100 mA, tp = 20 ms	4	9	16	mW/sr	
Ι _Ε	Radiant Intensity QEE123	F = 100 mA, tp = 20 mS	8	9		11107/51	
TCIE	Temperature Coefficient			-0.3		%/°C	
t _r	Rise Time I _F = 100 mA			900		ns	
t _f	Fall Time			800		ns	
Cj	Junction Capacitance	V _R = 0 V		11		pF	





FAIRCHILD. TRADEMARKS The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks. AccuPower™ F-PFS™ **OPTOPLANAR[®]** AttitudeEngine™ FRFET® Awinda[®] AX-CAP[®]* Global Power Resource SM ® TinyBoost[®] TinyBuck GreenBridge™ Power Supply WebDesigner™ BitSiC™ TinyCalc™ Green FPS™ PowerTrench Build it Now™ TinyLogic® Green FPS™ e-Series™ PowerXS™ CorePI US™ Gmax™ TINYOPTO™ Programmable Active Droop™ CorePOWER™ TinyPower™ GTO™ QFĔT CROSSVOLT™ TinyPWM™ IntelliMAX™ QS™ TinvWire™ CTL™ Quiet Series™ Current Transfer Logic™ TranSiC™ Making Small Speakers Sound Louder RapidConfigure™ **DEUXPEED**[®] and Better TriFault Detect™ Dual Cool™ TRUECURRENT®* MegaBuck™ Saving our world, 1mW/W/kW at a time™ **EcoSPARK[®]** MICROCOUPLER™ μSerDes™ SignalWise™ EfficientMax™ MicroFET™ SmartMax™ ESBC™ MicroPak™ SMART START™ MicroPak2™ F UHC Solutions for Your Success™ MillerDrive™ Ultra FRFET™ Fairchild® SPM[®] MotionMax™ UniFET™ Fairchild Semiconductor® STEALTH™ MotionGrid® VCX™ FACT Quiet Series™ SuperFET[®] MTi[®] VisualMax™ FACT[®] FAST[®] SuperSOT™-3 MTx® VoltagePlus™ SuperSOT™-6 MVN® XS™ FastvCore™ SuperSOT™-8 mWSaver® Xsens™ FETBench™ SupreMOS[®] OptoHiT™ 仙童™ **FPS**TM SyncFET™ **OPTOLOGIC[®]** Sync-Lock™ * Trademarks of System General Corporation, used under license by Fairchild Semiconductor. DISCLAIMER FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE DSEMI.COM. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS. LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein: 1. Life support devices or systems are devices or systems which, (a) are 2. A critical component in any component of a life support, device, or intended for surgical implant into the body or (b) support or sustain system whose failure to perform can be reasonably expected to life, and (c) whose failure to perform when properly used in cause the failure of the life support device or system, or to affect its accordance with instructions for use provided in the labeling, can be safety or effectiveness. reasonably expected to result in a significant injury of the user. ANTI-COUNTERFEITING POLICY Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support. Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full reaceability and our Authorized Distributors will standards for handling and storage and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors

PF	20	DUC	T STATU	S DEFINITIONS
-	~			

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
		Rev. 174